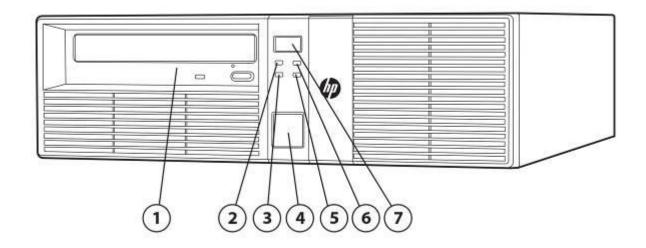
Overview

HP RP5 Retail System, Model 5810

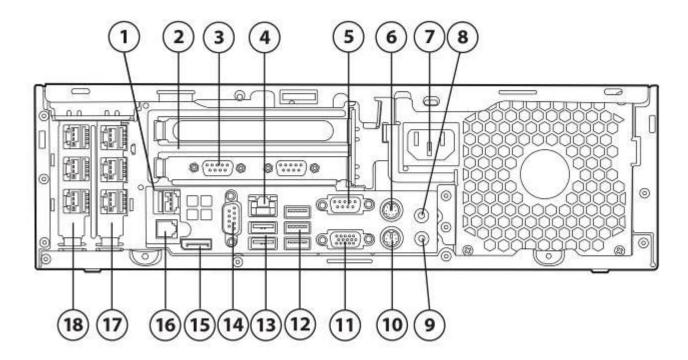


Front View

- 1. 5.25" external optical drive
- 2. Power/ Diagnostic LED
- 3. NIC Activity indicator LED
- 4. 2 USB 2.0 ports with sliding door

- 5. NIC Link indicator LED
- 6. Hard Drive LED
- 7. Power button

Overview



1. 24 Volt USB + PWR port

- 2. Two (2) Full-Height Slots*
- 3. RS232 serial COM3
- 4. RJ-45 LAN jack
- 5. RS232 serial (power configurable) COM1 port
- 6. PS/2 mouse port
- 7. 240W EPA Active PFC power supply (no line switching required)
- 8. Line in audio jack
- 9. Line out audio jack

Rear View

- 10. PS/2 keyboard port
- 11. VGA port
- 12. 3 USB 2.0 ports
- 13. 2 USB 3.0 ports
- 14. RS232 serial (power configurable) COM2 port
- 15. DisplayPort
- 16. RJ12 cash drawer port
- 17. One (1) PCIe x16 Slot (wired as x16)** shown is optional three (3) port 12 Volt USB +Power Card
- 18. One (1) PCIe x16 Slot (wired as x4)** shown is optional three (3) port 12 Volt USB + Power Card

^{*} Can be configured either as two (2) PCI x1 or two (2) PCIe x1 Full-Height slots. Shown is optional 2 Port RS232 serial (power configurable) Card, COM4 port (left) and COM3 port (right port).

^{**}A variety of cards are available to populate slots, dependant on riser choice and connectors utilized. For full details, please contact your HP sales representative for configuration choices.

Overview

Introduction

Get the flexibility and expandability to control everything from the store floor to the back office with the HP RP5 Retail System, Model 5810, an all-around high-performer that stands up to the rigors of a retail environment so you can focus on making sales.

At A Glance

- UEFI BIOS developed and engineered by HP for better security, manageability and software image stability
- Intel Q87 Express chipset supporting Intel 4th generation Intel ® Core™ processors, featuring Intel HD Graphics and vPro
 Technology (available with select processors)
- One of the following pre-installed operating systems:
 - o Windows 10 Pro, 64-bit1
 - Windows 10 IoT Enterprise Pro Retail, 64-bit¹
 - Windows Embedded 8.1 Industry Pro Retail 64-bit²
 - Windows Embedded POSReady7 32-bit or 64-bit
 - FreeDOS
- Intel I217LM GbE integrated network connection
- DDR3L Synchronous Dynamic Random Access Memory (SDRAM)
- Integrated dual independent monitor support via VGA and digital DisplayPort v1.2 interfaces
- Discrete graphics options available
- 90% high efficiency energy saving power supply
- ENERGY STAR 6.0 qualified models available (dependent upon the desired configuration)
- Can be configured with multiple hard disk drives in a RAID array
- Industry leading Design for Environment standards
- Protected by HP Services, including standard 3-3-3 warranty and warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Tool-less serviceability features for easier upgrades and repairs
- 40°C ambient thermals standard.
- Optional HP Rear Port/Cable Control Cover Available
- Tool-less serviceability for easy upgrades and repair
- I/O ports including cash drawer port.
- Configurable Full-Height expansion slots; must choose either a PCI x1 Riser or PCIe x1 Riser. The choice of riser will affect which cards can be utilized.
- Either the PCI Riser or the PCIe Riser contain a Serial Port Connector, and if this connector is populated by a Serial Card then one of the riser bays is covered and cannot be used

NOTE: All models and features may not be available in all countries

[1] Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

[2] Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality.

[3] Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

[4] This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.



Operating Systems

Preinstalled Windows 10 Pro, 64-bit¹

Windows 10 IoT Enterprise Pro Retail, 64-bit¹ Windows Embedded 8.1 Industry Pro Retail 64-bit Windows Embedded POSReady7 32-bit or 64-bit

FreeDOS

Tested Microsoft Windows Server 2003 R2 Standard (32-bit & 64-bit)

Microsoft Windows Server 2008 R2 Standard (64-bit) Microsoft Windows Server 2012 R2 Standard (64-bit)

Certified Novell SUSE Linux Enterprise Desktop†

[1] Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

[2] Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality.

[3] Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

[4] This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data

† The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Broadcom NetXtreme Gigabit Ethernet Plus
- HP ProtectTools
- HP Blu-ray Writer playback of commercial movies
- DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features
- Systems configured with Linux do not qualify for ENERGY STAR



Value Added Software (included with all models; not included when configured with FreeDOS)

HP ProtectTools Security Suite HP Vision Diagnostics

HP Software Management Agent PDF Complete Corporate Edition
HP Computrace Microsoft Office 2013 Starter

HP Client Management Solutions (available for free download from the Internet)

http://www.hp.com/go/easydeploy

HP SoftPaq Download Manager
HP Client Catalog for Microsoft SMS
HP Client Automation Starter

Retail Solutions Services and Features

Intel® Stable Image Platform Program (SIPP)

Factory Express Deployment and Lifecycle Services

Intel® vPro™ Technology* Intel® Standard Manageability

HP Global Series Services Trusted Platform Module (TPM) v1.2**

Service and Support

On-site warranty and service¹: This limited warranty and service offering delivers parts, labor and on-site repair for terms up to 5 years. Response time is next business day² and includes free telephone support³ 24 x 7. Global coverage² ensures any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labor.

1 Terms and conditions may vary by country. Certain restrictions and exclusions apply

2 On-site services may be provided pursuant to a service contract between HP and an authorized HP third party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country 3 Technical telephone support applies only to HP configured, HP and HP qualified third party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Chipset

Intel® Q87 Express

Processor

Intel® Celeron® Processors

Intel® Celeron® G1820 Processor
2.7GHz
2MB cache, 2 cores, 2 threads
Intel® GT1 – HD Graphics
Supports DDR3 memory up to 1333 MT/s data rate

Intel® Pentium® Processors

Intel® Pentium® G3420 Processor
3.2GHz
3MB cache, 2 cores, 2 threads
Intel® GT1 − HD Graphics
Supports DDR3 memory up to 1600 MT/s data rate
Intel® 4th Generation Core™ i3 Processors
Intel® Core™ i3-4150 Processor



3.5GHz

^{*}Intel® vPro™ Technology available on models with Intel® Core™ i7 and Intel® Core™ i5 processors.

^{**}TPM module disabled where restricted by law, i.e. Russia.

3MB cache, 2 cores, 4 threads Intel® HD Graphics 4400 Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4330 Processor

3.5GHz

4MB cache, 2 cores, 4 threads Intel® GT2 – 4600 Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® 4th Generation Core™ i5 Processors

Intel® Core™ i5-4570S Processor

Up to 3.6GHz Max. Turbo Frequency (2.9GHz Base Frequency)

6MB cache, 4 cores, 4 threads

Intel® GT2 - 4600 Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)

Intel® 4th Generation Core™ i7 Processors

Intel® Core™ i7-4770S Processor

Up to 3.9GHz Max. Turbo Frequency (3.1GHz Base Frequency)

8MB cache, 4 cores, 8 threads

Intel® GT2 - 4600 Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)

NOTE: Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Intel® vPro™ Technology

HP RP5 Retail System, Model 5810 platforms featuring this technology include processors that are part of the Intel 2013 Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP RP5 Model 5810, thus making this model the most stable, secure, and manageable platforms available to retailers today.

Intel Advanced Management Technology (AMT) v9.0 – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection



Standard Features and Configurable Components (availability may vary by country)

- Remote Scheduled Maintenance pre-schedule when the Retail System connects to the IT or service provider console for maintenance. Remote Retail Systems can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Point of Sale/Desktop (WoDT)
- Enhanced KVM resolution

Redundant Array of Independent Drives (RAID)

Flexible implementation:

- DriveLock is supported while in RAID mode. Users can manage the DriveLock password from within F10 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE:

RAID 1 is the only RAID configuration offered via HP factory configurations. The pre-configured systems:

- are complete RAID systems and have both drives installed.
- have the necessary Option ROM configuration.
- are pre-loaded and pre-installed with all required Intel software.
- include a preinstalled operating system that is mirrored mode out of the box.

Please refer to the HP White Paper titled "Advanced Host Controller Interface (AHCI) and Redundant Array of Independent Disks (RAID) on HP Compaq PCs" at: http://www.hp.com for more information and instructions.



DDR3 Synchronous DRAM NON-ECC System Memory

The HP RP5 Retail System, Model 5810 supports the 4th generation Intel® Core™ processor family. Based on a new microarchitecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small
- Outline dual in-line memory modules (U-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- · Theoretical maximum memory bandwidth of:
 - o 21.3 GB/s in dual-channel mode assuming 1333 MT/s
 - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

CAUTION: You must shut down the Retail System and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the Retail System is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

Memory Configurations:

Maximum Memory

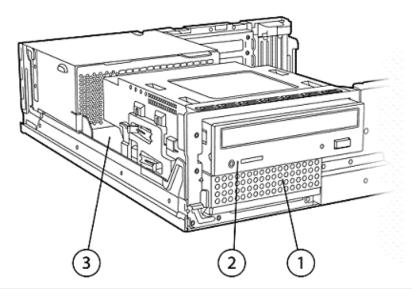
Supports up to 32 GB of DDR3 SDRAM using DIMM modules. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Total Memory	Slot			
	Channel A		Channel B	
	1 (black)	2 (white)	3 (black)	4 (white)
4 GB (dual channel symmetric)	4 GB			
8 GB (dual channel symmetric)	4 GB	4 GB	4 GB	4 GB
16 GB (dual channel symmetric)	4 GB	4 GB	4 GB	4 GB
32GB (dual channel symmetric)	8 GB	8 GB	8 GB	8 GB

NOTE: The Intel Q87 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the POS System contains a single U-DIMM, 16 MB of memory is pre-allocated for it at system startup. If the POS System contains two U-DIMMs, 32 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.





Front View	Quantity Supported	Position	Controller
3.5-inch SATA Hard Drive	3	1, 2*, 3	SATA
Optical Drive Bay or Carrier for Hard Drive	1	2	SATA

External HDD can be connected through optional external ESATA port. 3 Drive maximum **NOTE:** When ESATA is installed, either the 2nd HDD (if applicable) or ODD (if applicable) cannot be used. * For CRU Removable storage in lieu of ODD

Data Storage Drives

SATA Hard Disk Drives

HP 500GB SATA 3.0 Hard Disk Drive (3.5")

7,200 rpm, 16MB cache, 6.0 GB/s, NCQ, Smart IV

HP 1TB SATA 6G Hard Disk Drive (3.5")

7,200 rpm,

HP 2TB SATA 3.0 Hard Disk Drive (3.5")

7,200 rpm, 16MB cache, 6.0 GB/s, NCQ, Smart IV

HP 3TB SATA 3.0 1st Hard Disk Drive (3.5")

7,200 rpm, 16MB cache, 6.0 GB/s, NCQ, Smart IV

HP 500GB SATA (2.5")

7,200 rpm, 16MB cache, 6.0 GB/s, NCQ, Smart IV

SATA SED Hard Disk Drives

500GB SATA (2.5") w/ca SED HDD 7,200 rpm w/ca

Solid State Drives (2.5" Drives use a 3.5" drive cage adapter)

HP 64GB 2.5" SSD

HP 128GB Turbo Drive M.2 PCIe SSD card (optional)

HP 128GB 2.5" w/ca SSD

HP 128GB SATA TLC 2.5" SSD Drive

HP 256GB SATA TLC 2.5" SD Drive

HP 128GB 2.5" SED SSD

HP 256GB 2.5" SED SSD



Standard Features and Configurable Components (availability may vary by country)

128GB SATA 2.5 w/ca Opal2 SED SSD (optional) 256GB SATA 2.5 w/ca Opal2 SED SSD (optional) 512GB SATA w/ca SSD

Optical Disc Drive

HP SATA DVD-ROM Drive

NOTE: Optical drives are optional or add on features. Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives. Note that DVD-RAM cannot read or write to 2.6GB Single Sided/5.2 Double Sided-Version 1.0 Media.



Security Solutions and Capabilities

Trusted Platform Module (TPM) 1.21

Stringent security (via BIOS)2

SATA port disablement (via BIOS)

Drive lock

RAID configurations

HP ProtectTools Security Software Suite

Serial, parallel, USB enable/disable (via BIOS)

Optional USB Port Disable at factory (user configurable via BIOS)

Power Configurable Serial Ports (COM 1, 2, 3 and 4) via the HP BIOS

Removable media write/boot control

Power-On password (via BIOS)

Setup password (via BIOS)

HP Hood Sensor

TPM 1.2 Embedded Security Chip* integrated with Broadcom NIC

HP ProtectTools Security Software Suite with BIOS Configuration (serial (all 4), parallel, USB enable / disable), Credential Manager, Smart Card Manager (sold separately)

Three (3) port 12 Volt USB + PWR Card (sold separately)

Two (2) port Power Configurable RS232 Serial Card COM 3 & 4 (sold separately)

Wall Mount (sold separately)

HP Desktop Security Lock Kit (lock and cable) (sold separately)

Security Cable with Kensington lock (sold separately)

HP Rear Port/Cable Control Cover (sold separately)

NOTE: TPM module disabled where use is restricted by law; for example, Russia.

¹ TPM module disabled where use is restricted by law; for example, Russia.

² This setting is defaulted to disable, but when enabled, the PW jumper will not clear the BIOS pre-boot authentication passwords.

I/O Ports

USB USB 2.0:

Front: Two (2), covered

Rear: Three (3)

USB 3.0:

Rear: Two (2)

USB 24V One (1) 24V powered USB

Serial Two (2) RS-232 (power configurable) ports standard

Parallel One port available as an option*
eSATA One port available as an option*

RS-232 Two (2) RS-232 powered configurable ports optional (for a total of 4*)

USB+PWR 12V Two (2) USB+PWR 12V cards optional (three (3) 12 Volt USB+ PWR per card) for a total of 6*

PS/2 One (1) color-coded support for keyboard (purple)

One (1) color-coded support for mouse (green)

RJ-12 One (1) RJ-12 Cash Drawer port

Video One (1) VGA

One (1) DisplayPort v1.2 and One (1) DisplayPort v1.2 as an option*

Provides integrated dual independent monitor support

DVI output Available via optional DisplayPort to DVI Adapter

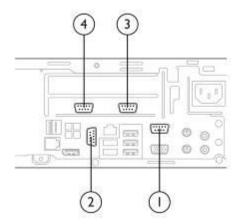
Audio Rear: Line input (supports microphone or line input) and line out

All ports are 3.5mm in diameter

NOTE: See Audio/Visual section for information on re-taskable audio ports

NIC One (1) Industry standard RJ-45 port accesses the integrated network interface controller

Serial Ports (Power Configurable in HP Bios) - detail



1 and 2: Powered Configurable serial port expansion card installation that supplies two additional serial ports (COM3 and COM4)

3 and 4: Two Power Configurable serial ports, COM1 and COM2, are standard on the POS System.

^{*}These options occupy slot openings so less slots will be available when the options are installed

Technical Specifications

Slots

Full-Height Total of Two (2) Full-Height Slots, with a **Choice of either**:

1.) PCI x1 - Two (2) each: 4.2" full height, 6.6" length, 25W max. power 2.) PCIe x1 - Two (2) each: 4.2" full height, 6.6" length, 10W max. power

Half-Height Total of Two (2) Half-Height:

PCIe x16 (wired as x4) - One (1) each: 2.5" low profile, 6.6" length, 10W max. power PCIe x16 (wired as x16) - One (1) each: 2.5 low profile, 6.6" length, 25W max. power

Bays

External 1 each 5.25" **Internal HDD** 2 each 3.5"

Controllers

Hard drive SATA

Supports up to SATA 6.0 Gb/s

SATA interfaces One (1) SATA 2.0

Two (2) SATA 3.0

Host SATA Advanced Host Controller Interface (AHCI) Revision 1.2. The specification includes a description of

the hardware/software interface between system software and the host controller hardware

Network Interface Connections

Intel I210-T1 PCIe x1 Gb NIC (optional)

Intel I217LM GbE Network Connection (integrated)

Intel 7260 802.11 a/b/g/n Wireless PCIe CLink NIC (optional)

Intel® Dual Band Wireless-AC 7265 802.11a/b/q/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo (non-vPro)

Broadcom NetXtreme GgE PCIe NIC (optional)

NOTE: The integrated network connection is required to support Intel vPro Technology. 802.11 requires wireless access point and internet service. Availability of public wireless access points limited. Gigabit Ethernet speeds may vary.

Graphics

Integrated:

Intel HD Graphics (integrated)
Intel HD Graphics 4600

Discrete:

NVIDIA Quadro NVS 315 Graphics 1GB NVIDIA Quadro NVS 510 Graphics 2GB

NOTE: HD content required to view HD images. Integrated Intel HD graphics uses part of the total system memory for video performance. System memory dedicated to video performance is not available for other use by other programs.

HP DisplayPort to DVI-D Adapter
HP DisplayPort to VGA Adapter



Technical Specifications

Multi-Media

High Definition Audio (integrated) with Realtek ALC261 codec (all ports are stereo)

Line-out and Line-In rear Ports (3.5mm)

Internal Speaker (standard)

Input/Output Devices

HP USB 1000dpi Laser Mouse (optional)

HP PS/2 Standard Keyboard for Retail (optional)

HP PS/2 Optical Mouse (optional)

HP USB Standard Keyboard for Retail (optional)

HP USB Optical Mouse (optional)

Miscellaneous Devices and Configurations

HP Parallel Port Adapter

HP Serial Port Adapter

HP Tower Stand

HP Rear Port/Cable Control Cover

HP RP5 Model 5810 PCI Riser Assembly

HP RP5 Model 5810 PCIe Riser Assembly

Three (3) port 12 Volt USB + Pwr Card

Two (2) port RS232 Serial (power configurable) COM 3 & 4 port card

Weights & Dimensions

(configured with 1 HDD & 1 ODD)

Chassis 13.3 x 14.9 x 3.95 in 33.8 x 37.9 x 10cm $(H \times W \times D)$

System Volume 788 cu in

13.0 L

Packaging 23.38 x 19.68 x 9.00 in $(H \times W \times D)$ 59.38 x49.99 x22.85 cm

System Weight* 15.08 lb

6.84 kg

Shipping Weight* 16.28lb

7.34kg

Max Supported Weight 77.0 lb (desktop orientation) 35.0 kg

* Exact weight depends on

configuration



Technical Specifications

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the POS System away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2-cm (4-in) clearance on front side and power supply side of the POS System to permit the required airflow.
- If within an enclosure, the front side should be 100% open. The clearance between the system and the cabinet must be at least 10 mm (0.4 inch) on the sides and top and at least 50-mm (2-inch) clearance in the rear with power supply venting area 100% open per the above bullet.
- Never restrict airflow into the POS System by blocking any vents or air intakes.
- Do not stack POS Systems on top of each other or place POS Systems so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the POS System. Lint, dust and other foreign matter can block the vents and limit the airflow.

Temperature Range	Operating: 50° to 104° F (10° to 40° C)* Non-operating: -22° to 149° F (-30° to 65° C)	
Relative Humidity	Operating: 20% to 85% (non-condensing at ambient) Non-operating: 0% to 95% (non-condensing at ambient)	
Maximum Altitude (unpressurized)	Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m)	

^{*} Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply

240-watt – EPA90 power supply – Active PFC

*This power supply meets ENERGY STAR compliance in conjunction with a select range of processors and modules.

4A Efficiency 87/90/87% at 20/50/100% load

Operating Voltage Range90 to 264 VACRated Voltage Range100 to 240VACRated Line Frequency50/60 HzOperating Line Frequency Range47 – 63 Hz

Rated Input Current

Power Supply Fan 90 mm variable speed fan ENERGY STAR Compliant ENERGY STAR 6.0 compliant Power Cord Length 6.0ft (1.8 3m)

Current Leakage (NFPA99) 5.01t (1.83)



Technical Specifications

ROM BIOS Information

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP RP5 Retail System,
 Model 5810 into retail, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Select models feature either Intel Standard Manageability or vPro Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP RP5 Retail System, Model 5810 in any retail environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade the HP RP5 Retail System, Model 5810, including BIOS updates from within DOS (Flashbin), BIOS updates from within Windows (HPQFlash), HP Client Manager, and failsafe recovery. In addition, the HP RP5 Retail System, Model 5810 BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be
 made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP RP5 Retail
 System, Model 5810 use ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the HP RP5 Retail System, Model 5810 to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

Other Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- System Management BIOS v2.7
- Intel Wired for Management support; industry wide initiative to make Intel architecture based Retail Systems, PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button



Technical Specifications

Serviceability Features

- Dual colored power LED on front of the HP RP5 Retail System, Model 5810 to indicate either normal or fault condition
- Indicator Lights on front of system:

Power / Diagnostic LED	Hard Drive LED
NIC Activity LED	NIC Link LED

- Diagnostic LED Explanation Table:
 - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- System/Emergency ROM
- NIC Link and activity LED's on front bezel
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber) Rear
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power button
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, Optical Drive Removal

NOTE: thumb screw release mechanism is used with the Ultra-slim Desktop chassis cover.



Technical Specifications

Additional Features

Intel® Standard Manageability

Description

- Requires the utilization of the integrated network connection
- Delivered with processors that are not part of the Intel Stable Intel Platform Program (SIPP)
- Intel Advanced Management Technology (AMT) v9.0
- Basic Retail SYSTEM management capabilities such as asset inventory, HW alerting, SOL/IDE-R, remote configuration, agent presence and system defense.
- DASH 1.1 compliance. Support for profile updates.
- Host VPN support for local management VPN tunneling

Intel Standard Manageability includes features of Intel Active Management Technology (Intel AMT). Intel AMT requires the Retail system to have an Intel AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. For more information, see http://www.intel.com/technology/platform-technology/intel-amt/.

DASH 1.1 support (Desktop and Mobile Architecture for System Hardware)

A standards initiative for representing out-of-band management capability for Retail Systems. It is a secure, web-services based successor to ASF.

ASF 2.0 support (Alert Standard Format)

Industry-standard specification for network alerting in operating system-absent environments

TXT allows for secure management (via TPM) and measured launch of VMM, as well as teardown of secrets in unexpected reset case. TXT support provided in select Intel processors

TXT (Trusted Execution Technology) and VT-d (Virtualized devices)

VT-d is a chipset technology that virtualizes directed I/O

Together, TXT and VT-d may be used to support verified launch of a known trusted VMM that also may protect VMs from accessing each other's memory.

Computrace

Computrace agent support standard

Towerable Orientation The chassis can be oriented as either a desktop or a tower.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user

Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the Retail System's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and

needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology)

Drive Protection System

Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

SMART I – Drive Failure Prediction

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count

 ${\sf SMART\,II-Off-Line\,Data\,Collection}$

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure

SMART III – Off-Line Read Scanning with Defect Reallocation

SMART IV - End-to-End CRC for hard drives

IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

Interface in F10 setup provides confirmation of SMART IV support.

(17)

Technical Specifications - Audio

High Definition Audio

Type Integrated

HD Stereo Codec Realtek 2-channel ALC221 codec

Audio I/O Ports Rear Line-In/Microphone input (47-K ohm Input Impedance, function is configurable by audio

driver)

Rear Line-Out* (200 ohms Output Impedance, expects at least a 10-K ohm load)

Line-in and Line-out, both on rear. All ports are 3.5mm in diameter

Internal Speaker Amplifier 1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear

Line-in audio port is re-taskable as either Line-in or Microphone-In.

Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams **Multi-streaming Capable**

to be sent to/from the front and rear jacks.

Sampling 8 kHz - 192 kHz

Wavetable Syntheses

(software) **Analog Audio** Yes

of Channels on Line-Out

(mono/stereo)

Internal Speaker

Yes **External Speaker Jack**

(Line-Out)

Stereo (Left & Right channels)

Yes - Uses OS soft wavetable





Technical Specifications - Communications

Intel® I217LM GbE Network Connection (integrated)

Connector RJ-45

System Interface Integrated on PCA

Controller Intel I217LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data rates supported 10/100/1000 Mbps

802.1P 802.1Q 802.2

Compliance 802.3

802.3ab 802.az 802.3u

Bus architecture PCI Express and SMBus

Data transfer mode PCIe-based interface for active state operation (SO state) and SMBus for host and management

traffic (Sx low power state)

Power requirement Requires 3.3V and 0.9V or just 3.3V with integrated regulators

Power consumption 0.733 Watts

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex)20 Mbps100BASE-TX (half-duplex)100 Mbps100BASE-TX (full-duplex)200 Mbps1000BASE-T (full-duplex)2000 Mbps

Environmental Operating Temperature: 32° to 185°F (0° to 85° C)

Operating Humidity: 60% RH

Management WOL, auto MDI crossover, PXE, Multi-port teaming, RSS, Advanced cable diagnostic.

Alerting ASF 2.0 support, AMT 9.0 support

Intel Ethernet I210-T1 GbE NIC Card

Connector RJ-45

System Interface PCI Express x1

Controller Intel I210 Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control

Bus architecture PCI Express 2.1

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer modeBus-master DMA

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union

Power requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM support Yes



Technical Specifications - Communications

Network transfer mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex)20 Mbps100BASE-TX (half-duplex)100 Mbps100BASE-TX (full-duplex)200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating Temperature: 32° to 131°F (0° to 55° C)

Operating Humidity: 85% at 131° F (55° C)

Dimensions 2.56 x 2.17 x 0.8 in (6.5 x 5.5 x 2.0 cm)

Management capabilities WOL, PXE, DMI, WFM 2.0

Intel 7260 802.11 a/b/g/n PCIe x1 WLAN Card

Wireless LAN standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
Wi-Ei cortified

Interoperability Wi-Fi certified

Cisco Compatible Extensions Program compliant with Microsoft Windows 7, Windows Vista and

XP (details at: http://www.hp.com/go/notebooks/WLAN)1

Frequency band 802.11b/g/n 2.402 - 2.482 GHz

802.11 a/n 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

Antenna structure 2 transmit; 2 receive (2x2)

Data rates 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

Modulation Direct Sequence Spread Spectrum

CCK, BPSK, QPSK, 16-QAM, 64-QAM

• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES

WPA2 certificationIEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAP

Sub-channels Multinational support with frequency bands and channels compliant to local regulations.

Network architecture models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between band Access Points

Technical Specifications - Communications

Output power³2.4G: +13.5dBm minimum(approximately)5G: +12dBm minimum

Power Consumption Transmit mode 2.0 Watts

Receive Mode 1.6Watts

Idle mode4250mW (WLAN Associated)Idle mode100 mW (WLAN unassociated)

Radio off 75mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver sensitivity⁵ 802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm

(24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)

802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps)

802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm

(24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)

802.11n:-69 dBm (150 Mbps), -66 dBm (300 Mbps)

Antenna connections 2 U.FL type connectors (output impedance of 50 ± 2 ohms)

Form Factor PCI-Express Half-MiniCard

Dimensions 0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)

Weight Approx. 0.122 lb (55.7 g)

Operating voltage 3.3V +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED activity LED Amber - Radio OFF; LED White - Radio ON

OS Support Windows 8.1 Pro (64-bit)*

Windows 8.1 (64-bit)* Windows 8 Pro (64-bit)* Windows 8 (64-bit)*

Windows 7 Ultimate (32-bit)**
Windows 7 Ultimate (64-bit)**
Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**
Windows 7 Home Premium (32-bit)**
Windows 7 Home Premium (64-bit)**
Novell SUSE Linux Enterprise Desktop 11***

*Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See

http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***Most features not available on Linux.



Technical Specifications - Communications

Option kit contents

PCIe x1 card with full height bracket, rf antenna, antenna cable, separate low profile bracket, software CD and warranty.

- 1. WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.
- 2. Check latest software/driver release for updates on supported security features.
- 3. Maximum output power may vary by country according to local regulations.
- 4. In Power Save Polling mode and on battery power.
- 5. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® Dual Band Wireless-AC 7265 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo (non-vPro) Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

Wi-Fi certified

Interoperability Frequency Band

802.11b/g/n

2.402 – 2.482 GHz

Note:

The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

802.11a/n

- 4.9 4.95 GHz (Japan)
- 5.15 5.25 GHz
- 5.25 5.35 GHz
- 5.47 5.725 GHz
- 5.825 5.850 GHz

Note: Indonesia no support this band)

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11q: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security¹

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Ad-hoc (Peer to Peer)

Network Architecture

Models

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Output Power²

• 802.11b: +16dBm minimum



Technical Specifications - Communications

802.11g: +14dBm minimum802.11a: +14dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum
 802.11n HT40(2.4GHz): +12dBm minimum
 802.11n HT20(5GHz): +14dBm minimum

802.11n HT40(5GHz): +12dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 5 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -94dBm maximum

802.11b, 11Mbps: -86dBm maximum 802.11g, 6Mbps: -88dBm maximum 802.11g, 54Mbps: -74dBm maximum 802.11a, 6Mbps: -88dBm maximum 802.11a, 54Mbps: -74dBm maximum 802.11n, MCS07: -69dBm maximum 802.11n, MCS15: -66dBm maximum 802.11ac, 1SS, MCS-0: -86dBm maximum 802.11ac, 2SS, MCS-9: -61dBm maximum 802.11ac, 2SS, MCS-9: -58dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm

0r

Type 1630: 2.3 x 16.0 x 30.0 mm

Weight Type 2230 : 2.8g

Ur

Type 1630 : 2g

Operating Voltage 3.3v +/- 9%

Altitude

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology



Technical Specifications - Communications

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz **Number of Available** Legacy: 0~79 (1 MHz/CH) Channels BLE: 0~39 (2 MHz/CH)

Data Rates and Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput** BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity

Legacy

Modulation	0.01% BER	0.001% BER
GFSK	-80 dBm	-70 dBm
π/4-DQPSK	-80 dBm	-70 dBm
8DPSK	-80 dBm	-70 dBm

Self-configurable to optimize power conservation in all operating modes,

All necessary regulatory approvals for supported countries, including:

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Range Legacy Up to 33 ft (10 m)

BLE Up to 99 ft (30 m) USB 2.0 compliant

Electrical Interface

Bluetooth Software

Microsoft Windows Bluetooth Software

Supported **Link Topology**

Electrical Interface

Bluetooth Software

Supported

Point to Point, Multipoint Pico Nets up to 7 slaves

Security Full support of Bluetooth Security Provisions Certifications Microsoft Windows ACPI, and USB Bus Support **Bluetooth Profiles**

Supported

Power Management

Certifications Certifications

Bluetooth Profiles Supported

Bluetooth V4.1/V4.2 support feature

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

including Standby, Hold, Park, and Sniff

ETS 300 328, ETS 300 826

Technical Specifications - Graphics

Intel HD Graphics (integrated)

VGA Controller

Integrated

DisplayPort

Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream

Technology for a maximum of 3 displays (including the integrated panel)

Memory

Intel graphics do not have dedicated memory but utilizes some of the computer's system memory. The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected video content.

Maximum Graphics Memory Microsoft Windows 7 Windows 8
Up to 1.7GB Up to 1.8GB

Note: The actual amount of maximum graphics memory can be less than the amounts listed above depending on your computer's configuration.

Graphics/Video API Support

- The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
- Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
 - Encode/transcode HD content
 - Playback of high definition content including Blu-ray Disc
 - Superior image quality with sharper, more colorful images
- DirectX Video Acceleration (DXVA) support for accelerating video processing
 - o Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 7
- Windows 8, Linux OS Support
- DirectX 11.1
- OpenGL 4.0
- Open CL 1.2

Resolution	Refresh Rates (Hz)
800x600	60
1024x768	60
1280x600	60
1280x720	60
1280x800	60
1280x960	60
1280x1024	60
1360x768	60
1366x768	60
1440x1050	60
1440x900	60
1600x900	60
1600x1200*	60
1680x1050	60
1920x1080	60
1920x1200*	60
1920x1440*	60
2560x1440*	60
2560x1600*	60

Technical Specifications - Graphics

* Only supported when using a DisplayPort connector

NVIDIA NVS 315 1GB PCIe x16 Graphics Card

Form Factor Low Profile: 2.713 × 6.15 in

Graphics Controller NVIDIA® NVS 315

Bus TypePCIe x16, 2.0 Compliant

Memory
Size: 1GB, 64bit wide bus

Clock: 875 MHz

Memory Bandwidth: 14 GB/s

Connectors DMS-59, with support for dual VGA, dual DVI or dual DisplayPort with the appropriate adapter

cable.

NOTE: Optional cable required for DVI and DisplayPort connectivity.

Display Max. Resolution

Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort

Display Output Up to 2 displays in the following configurations

Dual DVI:

 Drives two DVI displays using optional HP DMS59 DVI Dual-head Connector Cable DL139A

• Dual DisplayPort:

 Drives two DisplayPort using optional HP DMS-59 to Dual DisplayPort kit XP688AA

Dual VGA:

o Drives two analog using the included HP DMS-59 to Dual VGA Cable

Supported Display Resolutions and Refresh Rates NOTE: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP.

Resolution	Analog Connection	Digital Connection
640x480	85	60
720x480	85	60
720x576	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x768	85	60
1280x1024	85	60
1440x900	75	60
1600x1024	85	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A
2048x1536	75	N/A
2560x1440	N/A	60*



Technical Specifications - Graphics

60* 2560x1600 N/A

* Display Port Only

NVIDIA NVS 510 2GB Graphics Card

Form Factor Low Profile, 2.713 inches × 6.3 inches, single slot

Graphics Controller NVS 510 GPU

> Core Clock: 797 Mhz Memory Clock: 891 Mhz

CUDA Cores: 192

PCI Express™ x16 Generation 2.0 **Bus Type**

2GB DDR3 Memory

Connectors Four mini-DisplayPort.

Four mini-DisplayPort to DisplayPort adapters included.

(DisplayPort to DVI-D. DisplayPort to VGA, DisplayPort to HDMI, and DisplayPort to Dual-Link DVI

adapters available as separate accessories)

Maximum Resolution Mini-DisplayPort connectors support ultra-high-resolution panels (up to 3840 x 2160 @ 60Hz)

NOTE: This card supports up to four displays. For Windows XP, only 2 active displays are supported.

RAMDAC Not Applicable

Image Quality Features Display Output

10-bit internal display processing, including hardware support for 10-bit scan-out DisplayPort with Multi-Stream Technology (MST) and High Bit Rate 2 (HBR2) support.

Digital Display Support

1. DisplayPort Output

- Drives four DisplayPort enabled digital display at resolutions up to 3840 × 2160 at 60 Hz with reduced blanking, when connected natively using the 4 DisplayPort connectors on the NVS 510 graphics card.
- DisplayPort Multi-Stream Topology (MST) Technology: Supports various combinations of display resolutions and number of displays when using DisplayPort multi stream topology technology - up to a maximum of 4 monitors at a resolution of 1920 × 1200 at 60 Hz with reduced blanking.

2. DVI-D Output

- Drives four digital displays at resolutions up to 1920 x 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors.
- Drives four digital displays at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors.

3. HDMI Output

The NVS 510 graphics board is capable of driving four high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors.

Analog Display Support

1. VGA display output



60-R

QuickSpecs

Technical Specifications - Graphics

• Drives four analog displays at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors.

Supported Graphics APIs Full Microsoft DirectX 11, Shader Model 5.0 support

Full OpenGL 4.3 support

Power consumption 33.4 Watts

NOTE: Heatsink cooler design is active

HP DisplayPort to DVI-D Adapter

Connectors DisplayPort and DVI-D single link connector

Adapter length7.5 in (19.0 cm)Adapter weight.10 lbs (.05 kg)

HP DisplayPort to VGA Adapter

Connectors DisplayPort and VGA connector

Adapter length8 in (20 cm)Adapter weight.1 lbs (.06 kg)

Max. vertical refresh rate 85 Hz

Display support 162 MHz RAMDAC **Display max resolution** 1600x1200

Resolutions Supported	Resolution	Max refresh rate
	640x480	85
	800x600	85
	1024x768	85
	1280x720	85
	1280x1024	85
	1440x900	75
	1600x1200	60
	1680x1050	60
	1920x1080	60-R

1920x1200

NOTE:

Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP. Using the HP DisplayPort to VGA Adapter may require an update to the graphics driver installed on your system. To install the most up-to-date graphics driver go to: http://www.hp.com.

NOTE:

60-R denotes reduced blanking timings are used. Not all monitors support reduced blanking timing.



Technical Specifications - Data Storage Drives

HP Hard Disk Drives

HP 500GB Hard Disk Drive (3.5")

Capacity 500,107,862,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 GB/s

Buffer Size 16 MB **Logical Blocks** 976,773,168

Seek Time (typical reads, includes controller overhead,

including settling)

Single Track: 2.0 ms
Average: 11 ms
Full-Stroke: 21 ms

Height (nominal) 1 in/25.4 mm

Width (nominal) Media diameter: 3.5 in/88.9 mm

Physical size: 4 in/101.6 mm

Operating Temperature 41° to 131° F

5° to 55° C

HP 1TB Hard Disk Drive (3.5")

Capacity 1,000,204,886,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 GB/s

Single Track:

Buffer Size 32 MB

Logical Blocks 1,953,525,168

Seek Time (typical reads, includes controller overhead,

including settling)

Average: Full-Stroke:

ill-Stroke: 21 ms

2.0 ms

11 ms

Height (nominal) 1 in/25.4 mm

Width (nominal) Media diameter: 3.5 in/88.9 mm

Physical size: 4 in/101.6 mm

Operating Temperature 41° to 131° F

5° to 55° C

HP 2TB Hard Disk Drive (3.5")

Capacity 2,000,409,772,032 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 GB/s



Technical Specifications - Data Storage Drives

Buffer Size 64 MB

Logical Blocks 3,907,050,336

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:
Average:2.0 msAverage:
Full-Stroke:11 ms21 ms

Height (nominal) 1 in/25.4 mm

Width (nominal) Media diameter: 3.5 in/88.9 mm

Physical size: 4 in/101.6 mm

Operating Temperature 41° to 131° F

5° to 55° C

HP 3TB Hard Disk Drive (3.5")

Capacity 3.0 TB
Rotational Speed 7,200 rpm

Interface Serial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 GB/s

Buffer Size 64 MB

Seek Time (typical reads, includes controller overhead,

including settling)

Single Track: 0.6 ms Average: 11 ms

Full-Stroke: Not Specified

Height (nominal) 1 in/25.4 mm

Width (nominal) Media diameter: 3.5 in/88.9 mm

Physical size: 4 in/101.6 mm

Operating Temperature 41° to 131° F

5° to 55° C



Technical Specifications - Data Storage Drives

HP 500GB Hard Disk Drive (2.5" with caddy)

500,107,862,016 bytes Capacity

Rotational Speed 7,200 rpm

Interface Serial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 GB/s

Buffer Size 16 MB **Logical Blocks** 976,773,168

Seek Time (typical reads, Single Track: includes controller overhead, Average: including settling) **Full-Stroke:**

Height (nominal) 0.374 in/9.5 mm

Width (nominal) Media diameter: 2.5 in/63.5 mm

Physical size: 2.75 in/69.85 mm

2.0 ms

13 ms

25 ms

2.0 ms

13 ms

Operating Temperature 41° to 131° F

5° to 55° C

HP 500GB SED Hard Disk Drive (2.5" with caddy)

Capacity 500,107,862,016 bytes

7,200 rpm **Rotational Speed**

Interface Serial ATA (SATA) 3.0

Synchronous Transfer Rate Up to 6 GB/s

(maximum)

32 MB

Buffer Size Logical Blocks 976,773,168

Seek Time (typical reads, Single Track: includes controller overhead. Average: including settling)

Full-Stroke: 25 ms

Height (nominal) 0.267 in/6.8 mm

Media diameter: 2.5 in/63.5 mm Width (nominal)

Physical size: 2.75 in/69.85 mm

41° to 131° F **Operating Temperature**

5° to 55° C



Technical Specifications - Data Storage Drives

HP Solid State Drives

HP 64GB SATA Solid State Drive (2.5" with caddy)

Capacity63,023,063,040 bytesInterfaceSerial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 Gb/s

Logical Blocks 123,091,920

Height (nominal) 7mm

Width (nominal) Physical size: 70mm

Operating Temperature 0° to 70° C

HP 128GB SATA 3D Solid State Drive (2.5" with caddy)

Capacity128,035,676,160 bytesInterfaceSerial ATA (SATA) 3.0

Random Read IOPS (4KB): Up to 530 MB/s **Random Write IOPS (4KB):** Up to 140 MB/s

 Buffer Size
 256 MB

 Logical Blocks
 250,069,680

 Height (nominal)
 6.80 mm ± 0.20

 Width (nominal)
 69.85 mm ± 0.25

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA TLC Solid State Drive, 2.5"

Unformatted Capacity 256 GB*

Architecture TLC NAND Flash
Interface SATA 3.2 (6.0 Gb/s)
Dimensions (W x H x D) 6.98 x 0.7 x 10.05 cm

Weight 36.5 g

Bandwidth Performance Sustained Sequential Read: Up to 498 MB/s

Sustained Sequential Write: Up to 455 MB/s
Random Read: Up to 84K IOPs
Random Write: Up to 49K IOPs

Power DC power requirement: 5 VDC 5%-100 mV ripple p-p

Total power consumption: 95mW (active); 70mW (idle)

Useful Drive Life 72TB written, up to 40GB/day for 5

vears

Environmental Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-condensing) Relative Humidity: 5% to 95%

Shock: 1,500 G/0.5 ms

^{*} For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.



Technical Specifications - Data Storage Drives

HP 128GB SATA SED Solid State Drive (2.5" with caddy)

Capacity 128,035,676,160 bytes Interface Serial ATA (SATA) 3.0 Up to 530 MB/s Random Write IOPS (4KB): Up to 340 MB/s

Buffer Size 256 MB

Logical Blocks 250,069,680 (User Addressable Sectors)

Height (nominal) 6.80 mm ± 0.20 **Width** (nominal) 69.85 mm ± 0.25

Operating Temperature 32° to 158° F (0° to 70° C)

HP 128GB SATA Solid State Drive (2.5" with caddy)

Capacity 128,035,676,160 bytes
Interface Serial ATA (SATA) 3.0

Read Bandwidth Up to 530 MB/s

Write Bandwidth Up to 140 MB/s

 Buffer Size
 256 MB

 Logical Blocks
 250,069,680

 Height (nominal)
 6.80 mm ± 0.20

 Width (nominal)
 69.85 mm ± 0.25

Operating Temperature 32° to 158° F (0° to 70° C)

HP 128GB Turbo Drive Solid State Drive M.2 PCIe card

Capacity 128 GB SSD

NAND Type MLC

Read Bandwidth (128KB) 1.00GB/s

Write Bandwidth (1MB) 450 MB/s

Random Read IOPS (128KB): 110K

Random Write IOPS (1MB): 40K

Written)

Endurance (Total Bytes

Weight 1.8oz (51g)

From Factor Half-height, half-length

HP 256GB SATA Solid State Drive (2.5" with caddy)

73TB

Capacity256,060,514,304 bytesInterfaceSerial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 Gb/s



Technical Specifications - Data Storage Drives

Buffer Size256 MBLogical Blocks500,118,192

Height (nominal) 7mm

Width (nominal) Physical size: 70mm

Operating Temperature 0° to 70° C

HP 256GB SATA SED Solid State Drive (2.5" with caddy)

Capacity256,060,514,304 bytesInterfaceSerial ATA (SATA) 3.0

Synchronous Transfer Rate

(maximum)

Up to 6 Gb/s

Buffer Size 256 MB **Logical Blocks** 500,118,192

Height (nominal) 7mm

Width (nominal) Physical size: 70mm

Operating Temperature 0° to 70° C

HP Removable SATA Hard Drive Enclosure

Introduction

The HP Removable Hard Drive Enclosure supports up to 3 Gb/s SATA transfer rates along with Gold DIN connectors that are rated for 30,000 insertions and removals. Robust all-metal construction provides superior cooling while protecting the hard drive during transportation and storage. A powered key lock prevents theft or accidental removal during operation and a temperature sensing fan ensures sufficient airflow across the hard drive based on workload.

The HP Removable SATA Hard Drive Enclosure consists of two components; a receiving frame and a removable drive carrier. Install the receiving frame into the 5.25" optical storage bay and then relocate your primary system hard drive or secondary hard drive to the removable drive carrier. Then insert the drive carrier into the receiving frame and you have a fully configured removable hard drive.

Interface TypeCompatible with 3.5" SATA controllersDimensions (W x L x H)5.73 x 7.87 x 1.61 in (14.6 x 20 x 4.1 cm)Weight1.56 lbs (707 g) (not including hard drive)

HP DX115 Removable Drive Enclosure

Introduction

The HP DX115 Removable Enclosure is a rugged drive carrier and receiving frame for internally mounting a SATA hard drive into the 5.25 inch optical drive bay in the HP RP5 Retail System.

The DX115 supports one 3.5" SATA (Serial ATA) hard disk drive.

HP DX115 Removable HDD Frame/Carrier - A receiving frame and carrier for a SATA hard disk drive. The receiving frame
installs in one of the 5.25" optical bays in the HP RP5 Retail System. The carrier holds the HDD and has a quick release
handle for insertion/removal. You can install any HP supported 3.5" disk in the carrier.



Technical Specifications - Data Storage Drives

 HP DX115 Removable HDD Carrier - Use this carrier for adding spare or additional drives. Hard Drive purchased separately.

Performance and Features

Enclosure with centered drive carrier ensures no interference with the system bezel. Drive spin/power up/down button. Power, spin & fan failure indicator. Drive activity indicator (system-dependent). "Soft Start" circuitry & anti-static device protection. Cable-less drive connector. Rugged construction; drive is protected in the event of physical trauma. Mating connectors provide 25K insertion rating for multiple insertions and removals. Integrated fan assures proper drive cooling. Key lock functions independently from drive power

Interface Type Compatible with 3.5" SATA controllers
Dimensions (W x H x D) 147.6mm W x 41.1mm H x 205mm L

(5.81" W x 1.62" H x 8.08" L)

Weight Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)



Write

QuickSpecs

Technical Specifications - Input/Output Devices

HP DVD-ROM Drive

Height5.25-inch, half-height, tray-loadOrientationEither horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Read speeds DVD+R/-R/+RW/ Up to 8X

Media

-RW/+R DL /-R DL

 DVD-ROM
 Up to 16X

 DVD-RAM
 Up to 5X

 CD-ROM, CD-R
 Up to 40X

 CD-RW
 Up to 32X

Removable Storage - Media Compatibility - DVD-ROM

CD-ROM Yes No CD-R Yes No CD-RW Yes No **DVD-ROM** Yes No **DVD-ROM DL** Yes No **DVD-RAM** Yes No DVD+R Yes No DVD+R DL Yes No **DVD+RW** Yes No DVD-R Yes No **DVD-RW** Yes No DVD-R DL Yes No

Read

Access times Random DVD: < 140 ms (typical), CD: < 125 ms (typical) (typical reads, including setting) Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Cache Buffer 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA mode 2 (16.7

MB/s); ATA UltraDMA Mode 3 (44.4 MB/s -default)

Power Source SATA DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

12 VDC -< 600 mA typical, < 1400 mA maximum

Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions Relative Humidity 10% to 90% non-condensing) Maximum Wet Bulb 86° F (30° C)

Temperature

Technical Specifications - Input/Output Devices

HP USB Standard Keyboard for Retail

Physical characteristics Keys 104, 105, 106, 107, 109 layout (depending upon country)

Dimensions (L x W x H) 18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)

Weight 2 lb (0.9 kg) minimum

Electrical Operating voltage + 5VDC ± 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Mechanical Languages 38 available

Keycaps Low-profile design

Switch actuation55-g nominal peak force with tactile feedbackSwitch life20 million keystrokes (using Hasco modified tester)

Switch typeContamination-resistant switch membrane **Key-leveling mechanisms**For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity10% to 90% (non-condensing at ambient)Non-operating humidity20% to 80% (non-condensing at ambient)

Operating shock40 g, six surfacesNon-operating shock80 g, six surfacesOperating vibration2-g peak accelerationNon-operating vibration4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence **Drop** (in box) 42 in (107 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Kit contents Keyboard Installation Guide

Warranty Card Safety and Comfort Guide



Technical Specifications - Input/Output Devices

HP PS/2 Standard Keyboard for Retail

Physical characteristics Keys 104, 105, 106, 107, 109 layout (depending upon country)

Dimensions (L x W x H) 18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)

Weight 2 lb (0.9 kg) minimum

Electrical Operating voltage $+ 5VDC \pm 5\%$

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

MechanicalLanguages38 available

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Technical Specifications - Input/Output Devices

HP PS/2 Optical Mouse

Dimensions (H x L x W) 1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)

Weight 3.53 oz (100g; +10g/- 5 g)

Environmental Operating temperature 32° to 104°F (0° to 40° C)

Non-operating temperature -4° to 140° F (-20° to 60° C)

Operating humidity 10% to 90% (non condensing at ambient)

Non-operating humidity 10% to 90% (non condensing)

Operating shock40 g, 6 surfacesNon-operating shock80 g, 6 surfacesOperating vibration2 g peak accelerationNon-operating vibration4 g peak acceleration

Drop 80 cm height onto asphalt tile over concrete or equivalent, 5-

(out of box) drop in 5 direction except the cable face

Electrical Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector **ESD** CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Mechanical Resolution 800 DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

 $\begin{array}{lll} \textbf{Acceleration} & \pm \, 15\% \\ \textbf{Switch actuation} & 65 \pm 20 \, \text{gf} \end{array}$

Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 80km

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Scroll wheel Width 6 mm

Diameter $22.5 \pm 0.2 \text{ mm}$ Maximum rotation speed50 gf-cm

Switch type
Light force micro-switch
Switch life
1 million operations
Mechanical life
Max 200,000 revolutions
UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick

Regulatory Approvals

01/601, 1 cc, c1 Plank, 10 V/03, Vcci, kcc, 55kii, c 1

Compatibility Operating system support Windows 8, Windows 8 Pro, Windows 7, Windows 7

Professional, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows XP Professional or Windows XP Home 32* (no driver is required for

this device. Native support is provided by the operating

system.), xpe, ce.net, Linux, XP-64

Technical Specifications - Input/Output Devices

*Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit

http://www.windowsvista.com/systemrequirements.

HP USB Optical Mouse

Dimensions (H x L x W) 1.5x 4.5 x 2.5 in (3. 7x 11.5 x 6.3 cm)

Weight 0.22 lb (0.10 kg) (Typical weight with cable)

Cable length 70.9 in (180 cm)

System requirements Windows 8, Windows 8 Pro, Windows 7, Windows 7 Professional, Windows Vista Business 64*,

Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32* (No driver is required for this device. Native support is

provided by the operating system.), xpe, ce.net, Linux, XP-64



Technical Specifications - Environmental Data

Environmental Data

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US ENERGY STAR ®
- IT ECO declaration
- EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in your country.

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	38.55W	38.62W	38.42W
Sleep (Energy Star low power mode)	2.65W	2.90W	2.70W
Off	0.93W	1.12W	0.92W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured model.

Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	132 BTU/hr	132 BTU/hr	131 BTU/hr
Sleep	9 BTU/hr	10 BTU/hr	9 BTU/hr
Off	3 BTU/hr	4 BTU/hr	3 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off	m Fan Off Sound Power (LWAd, bels)	
Idle	3.7	28
Fixed Disk (random writes)	3.8	29

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium



Technical Specifications - Environmental Data

Additional information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 7.5% post consumer recycled plastic (by wt.)
- This product is 91.3% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - o Corrugated 1320 g
- Internal:
 - o Polyethylene low density foam 196 g
- The corrugated packaging material varies in recycled content:
 - North America at least 25% recycled content
 - Asia at least 62% recycled content (Singapore at least 80%)
 - Europe at least 50% recycled content
- The Polyethylene low density Foam packaging material varies in recycled content:
 - North America 100% (Pre-consumer or Post-industrial)
 - Asia 10%
 - Europe 7%

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/qlobalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances



Technical Specifications - Environmental Data

- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
- Nickel finishes that release greater than 0.5 micro-grams/cm²/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment: Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html



After-Market Options (availability may vary by region)

Communication Devices

	Part #
Broadcom NetXtreme Gigabit Ethernet Plus NIC	FS215AA
Intel Ethernet I210-T1 GbE NIC	E0X95AA
Intel 7260 802.11 a/b/g/n PCIe x1 WLAN Card	F2P07AA

NOTE:

The use of a discrete network interface connection card (wired or wireless) will disable the vPro Technology features.

Graphics Solutions

	Part #
NVIDIA NVS 315 1GB Graphics Card	E1U66AA
NVIDIA NVS 510 2GB Graphics Card	C2J98AA
HP DMS59 DVI Dual-head Connector Cable	DL139A
HP DMS-59 to Dual DisplayPort Adapter	XP688AA
HP DisplayPort Cable Kit	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	NR078AA
HP DisplayPort To DVI-D Adapter	FH973AA
HP DisplayPort to VGA Adapter	AS615AA
HP USB Graphics Adapter	NL571AA

Hard Disk Storage Drives

	Part #
HP 500GB SATA (6.0Gb/s) Hard Disk Drive	QK554AA
HP 1TB SATA (6.0Gb/s) Hard Disk Drive	QK555AA
HP 256GB SATA TLC Non-SED Solid State Drive	P1N68AA
HP DX115 Removable HDD Frame/Carrier	FZ576AA
HP DX115 Removable HDD Carrier	NB792AA
HP Removable SATA Hard Drive Enclosure (frame & carrier)	RY102AA
HP Removable SATA Hard Drive Enclosure (carrier only)	RY103AA

Input / Output Devices

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HP PS/2 Standard Keyboard for Retail	J4A10AA
HP USB Standard Keyboard for Retail	J4A11AA
HP 2-port Powered Serial Port Card	QP906AA
HP 12V PUSB Entry Card	QP905AA
HP PS/2 Optical Mouse	QY775AA
HP USB Optical Mouse	QY777AA

System Memory

	Part #
HP 4GB DDR3-1600 MHz DIMM	B4U36AA
HP 8GB DDR3-1600 MHz DIMM	B4U37AA

Part #

After-Market Options (availability may vary by region)

Multimedia Devices	
	Part #
HP DVD-ROM Drive	AR629AA
HP DVD-Writer Drive	QS208AA
HP Blu-ray Writer Drive	B4F70AA
Security Devices	
	Part #
HP Chassis Security Kit	AR639AA
HP Business PC Security Lock	PV606AA
HP Wall Mount/Security Sleeve	VN570AA
Accessories	
	Part #
HP rp5800 Trim Bezel – with ODD Opening	QP910AA
HP Integrated Work Center Stand	QP897AA
HP Tower Stand	VN569AA
HP Serial Port Adapter	PA716A
HP Parallel Port Adapter	KD061AA
HP PCIe x1 Parallel Port Card	N1M40AA
HP Rear Port / Cable Control Cover	QP909AA
HP 12V-PUSB card for the rp5 5810	J1V28AA



After-Market Options (availability may vary by region)

Retail Solutions Specific Accessories

	Part #
HP Standard Duty Cash Drawer	QT457AA
HP USB Standard Duty Cash Drawer	E8E45AA
HP Heavy Duty Cash Drawer	FK182AA
HP Flip-Top Cash Drawer	BW867AA
HP Till with Locking Cover	QT458AA
HP Flip-Top Till with Locking Cover	BZ335AA
HP Imaging Barcode Scanner	BW868AA
HP Imaging Barcode Scanner 7-foot Cable	BZ337AA
HP Linear Barcode Scanner	QY405AA
HP Presentation Barcode Scanner	QY439AA
HP Wireless Barcode Scanner	E6P34AA
HP POS Pole Display	FK225AA
HP Graphical Pole Display	QZ704AA
HP Mini MSR with Brackets	FK186AA
HP POS Keyboard without MSR	FK221AA
HP POS Keyboard with MSR	FK218AA
HP Powered USB Thermal Receipt Printer	FK224AA
HP Serial/USB Thermal Receipt Printer	BM476AA
HP Hybrid POS Printer with MICR	FK184AA
Epson H6000IV Hybrid POS Printer	D9Z51AA
Epson T88V PUSB Receipt Printer	E1Q93AA
EpsonT88V Serial USB Receipt Printer	D9Z52AA
HP Value PUSB Receipt Printer	F7M67AA
HP Value Serial/USB Receipt Printer	F7M66AA
HP USB Y Cable (for Serial USB Receipt Printer)	BM477AA
HP Cable Pack for Dual Cash Drawers	QT538AA
HP L5006tm 15-inch LCD (SAW) Touchscreen Monitor	RB146AA
HP L5009tm 15-inch LCD (APR) Touchscreen Monitor	VK202AA
HP L1506x 15-inch LED Monitor (Non-Touchscreen)	LL543AA
HP L6010 10.4-inch Monitor (Non-Touchscreen)	A1X76AA
HP Dual Position Stand for L6010	A1X79AA
HP L6015tm 15-inch (PCAP) Touchscreen Monitor	A1X78AA
HP L6017tm 17-inch (PCAP) Touchscreen Monitor	A1X77AA
HP Height Adjusting Stand for L6015/17tm	A1X81AA
HP Integrated Barcode Scanner	E1L07AA
HP Retail Integrated Fingerprint Reader	QZ672AA
HP Retail Integrated Webcam	QZ673AA
HP Retail Integrated Dual-Head MSR	QZ700AA
HP rp5800 Terminal Enclosure Assembly	QQ971AA
HP rp5800 Integration Tray Assembly	QQ972AA
HP Display Pole Mount Assembly	QQ973AA



HP RP5 Retail System, Model 5810

QuickSpecs

After-Market Options (availability may vary by region)

HP Optional Display Arm Assembly

QQ974AA



Summary of Changes

Date of change:	Version History:		Description of change:
	From v1 to v2		
May 16, 2014	From v6 to v7	Added	Add document ID to footnotes section, LCD Pole Display and 7-in CFD
December 8, 2014	From v7 to v8	Added	Intel Core i3-4150, 128GB M.2 PCIe SSD
January 21, 2015	From v8 to v9	Removed	HP 128 GB M.2 PCIe SSD
March 2, 2015	From v9 to v10	Changed	Intel Core i3 4330 specs in Overview section
March 1, 2015	From v10 to v11	Removed	HP 512GB SSD from Data Storage Drives
April 8, 2015	From v11 to v12	Changed	Callouts naming in front view, Overview section
April 17, 2015	From v12 to v13	Changed	Change to Indicator lights in Serviceability Features section
June 2, 2015	From v13 to v14	Added	128GB M.2 PCIe SSD, 128GB SATA 2.5 w/ca Opal2 SED SSD, 256GB SATA 2.5 w/ca Opal2 SED SSD, and 500GB 7200 RPM SATA 2.5 w/ca SED HDD to Storage. HP USB 1000dpi Laser Mouse to Input Devices
October 8, 2015	From v14 to v15	Added	32GB SSD availability note; HP PCIe x1 Parallel Port Card in AMO section
October 30, 2015	From v15 to v16	Added	9.5mm Slim DVD-ROM, HP 9.5mm Slim SuperMulti DVD-RW Drive, and detailed specs
December 14, 2015	From v16 to v17	Added	Windows 10 IoT Enterprise for Retail 64-bit, Windows 10 Pro 64-bit to Overview and Operative Systems
April 5, 2016	From v17 to v18	Removed	HP 256GB 2.5 SSD
May 22, 2016	From v18 to v19	Added	12V-PUSB card/J1V28AA, DVD ROM AMO kits
		Changed	Operative Systems and Storage offering,
October 3, 2016	From v19 to v20	Added	128GB & 256GB TLC SSD to Storage section; Intel 7265, 802.11ac non-vPro to Networking and Communications
		Removed	Win 7 and 8.1 Pro, DisplayPort to HDMI adapter
November 14, 2016	From v20 to v21	Changed	Memory slot color in Memory Configuration
January 1, 2016	From v21 to v22	Changed	All instances from SuperMulti DVD-RW to DVD-Writer
August 7, 2017	From v22 to v23	Changed	The HP 128GB Solid State Drive for the HP 256GB SATA TLC Non- SED Solid State Drive under Hard Disk Storage Drives sections
October 3, 2017	From v23 to v24	Removed	9.5mm Optical Drives



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